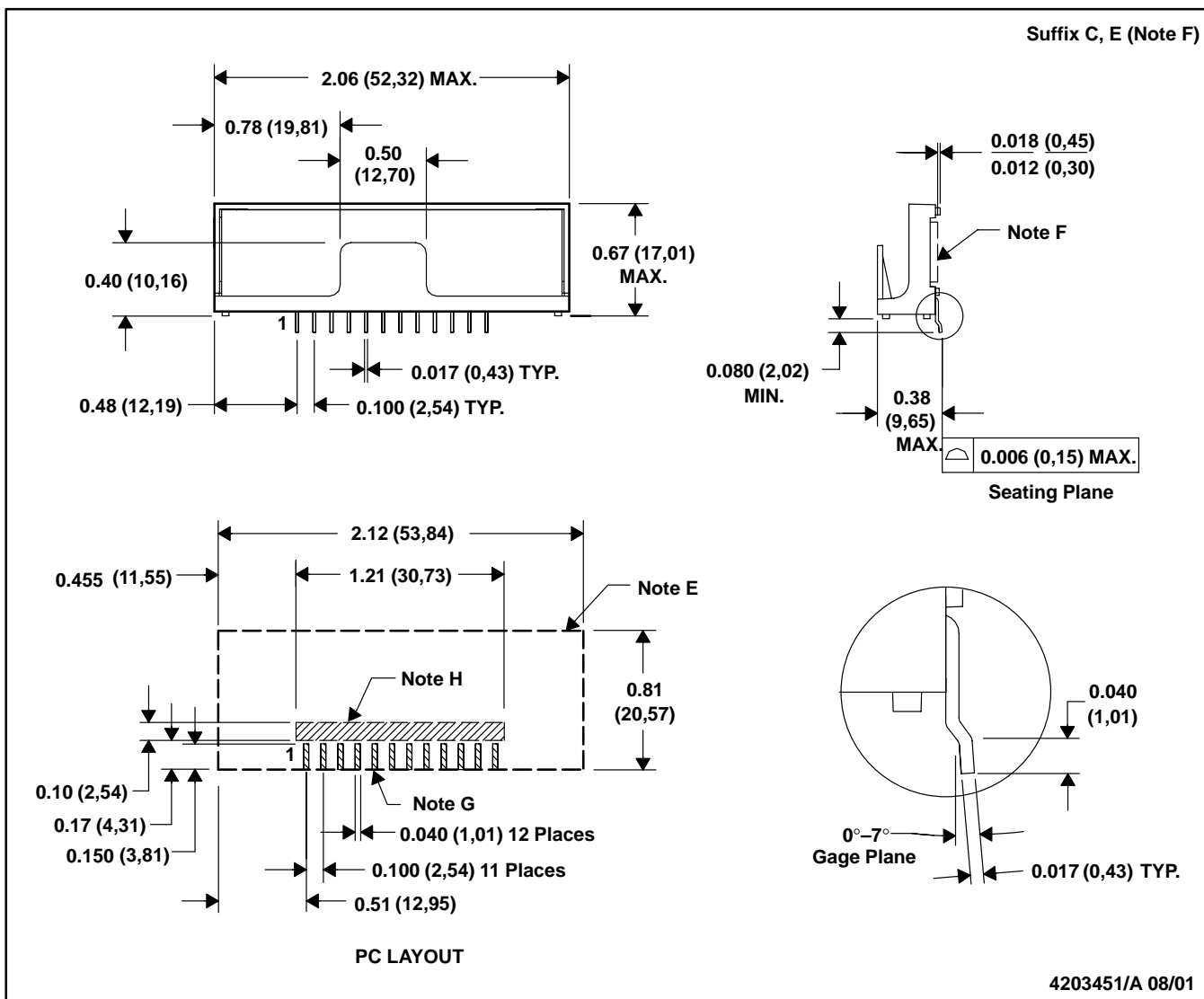


## ECC (R-PSIP-G12)

## PLASTIC SINGLE-IN-LINE MODULE



- NOTES:
- All linear dimensions are in inches (mm).
  - This drawing is subject to change without notice.
  - 2 place decimals are  $\pm 0.030$  ( $\pm 0,76$ mm).
  - 3 place decimals are  $\pm 0.010$  ( $\pm 0,25$ mm).
  - Recommended mechanical keep out area.
  - E-suffix parts include a metal heat spreader.  
No signal traces are allowed under the heat spreader area.  
A solid copper island is recommended, which may be grounded.
  - C-suffix do not include a metal heat spreader.
  - Power in pin connections should utilize two or more vias per input, ground and output pin.
  - No copper, power or signal traces in this area.

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